DUAL N-CHANNEL ENHANCEMENT MODE MOSFET
PowerDI5060-8

Product Summary

BV_{DSS}	$R_{DS(ON)}$ Max	I_D Max T_C = +25°C
100V	17.4mΩ @ V_{GS} = 10V	54.7A
	30.3mΩ @ V_{GS} = 4.5V	41.4A

Features and Benefits

- 100% Unclamped Inductive Switching—Ensures More Reliable and Robust End Application
- High-Conversion Efficiency
- Low $R_{DS(ON)}$—Minimizes On State Losses
- Low-Input Capacitance
- Fast Switching Speed
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC- Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/**

Description and Applications

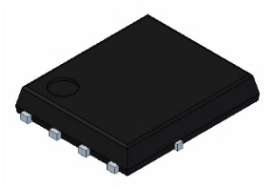
This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

- Synchronous Rectifier
- DC-DC Converters
- Primary Side Switching

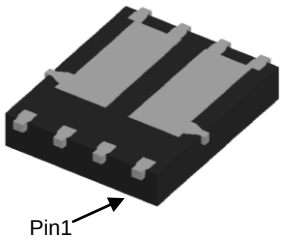
Mechanical Data

- Case: PowerDI®5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 e3
- Weight: 0.097 grams (Approximate)

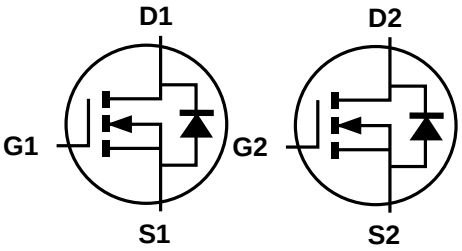
PowerDI5060-8 (Type E)



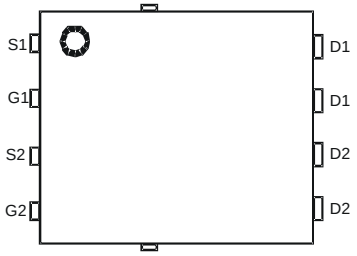
Top View



Bottom View



Equivalent Circuit



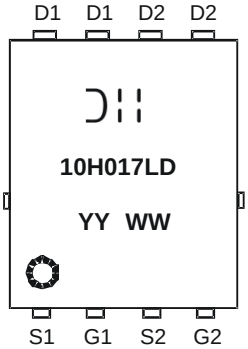
Top View
Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
DMT10H017LPD-13	PowerDI5060-8 (Type E)	2500 / Tape & Reel

Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3).compliant. All applicable RoHS exemptions applied.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



= Manufacturer's Marking
10H017LD = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 19 = 2019)
WW = Week (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	100	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current, V_{GS} = 10V (Note 6)	T_C = +25°C T_C = +70°C	I_D	54.7 43.7	A
Maximum Body Diode Forward Current (Note 6)		I_S	60	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I_{DM}	60	A
Avalanche Current, L = 3mH (Note 8)		I_{AS}	10	A
Avalanche Energy, L = 3mH (Note 8)		E_{AS}	150	mJ
Avalanche Current, L = 1mH		I_{AS}	10	A
Avalanche Energy, L = 1mH		E_{AS}	50	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation	T_A = +25°C	P_D	2.2	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\Theta JA}$	56	°C/W
Total Power Dissipation	T_C = +25°C	P_D	78	W
Thermal Resistance, Junction to Case (Note 6)		$R_{\Theta JC}$	1.6	°C/W
Operating and Storage Temperature Range		T_J, T_{STG}	-55 to +150	°C

Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV_{DSS}	100	—	—	V	V_{GS} = 0V, I_D = 1mA
Zero Gate Voltage Drain Current	I_{DSS}	—	—	1	µA	V_{DS} = 80V, V_{GS} = 0V
Gate-Source Leakage	I_{GSS}	—	—	±100	nA	V_{GS} = ±16V, V_{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(TH)}$	1	—	3	V	V_{DS} = V_{GS}, I_D = 250µA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	—	13.7	17.4	mΩ	V_{GS} = 10V, I_D = 17A
		—	23.5	30.3		V_{GS} = 4.5V, I_D = 10A
Diode Forward Voltage	V_{SD}	—	0.8	1.3	V	V_{GS} = 0V, I_S = 17A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C_{iss}	—	1986	—	pF	V_{DS} = 50V, V_{GS} = 0V, f = 1MHz
Output Capacitance	C_{oss}	—	333	—		
Reverse Transfer Capacitance	C_{rss}	—	20	—		
Gate Resistance	R_G	—	1.17	—	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz
Total Gate Charge (V_{GS} = 4.5V)	Q_g	—	14.4	—	nC	V_{DS} = 50V, I_D = 20A
Total Gate Charge (V_{GS} = 10V)	Q_g	—	28.6	—		
Gate-Source Charge	Q_{gs}	—	5.2	—		
Gate-Drain Charge	Q_{gd}	—	8.2	—		
Turn-On Delay Time	$t_{D(ON)}$	—	9.8	—	ns	V_{DD} = 50V, V_{GS} = 10V, R_G = 11Ω, I_D = 20A
Turn-On Rise Time	t_R	—	16.3	—		
Turn-Off Delay Time	$t_{D(OFF)}$	—	32.6	—		
Turn-Off Fall Time	t_F	—	21.6	—		
Body Diode Reverse Recovery Time	t_{RR}	—	40.6	—	ns	I_F = 17A, di/dt = 100A/µs
Body Diode Reverse Recovery Charge	Q_{RR}	—	58.1	—	nC	I_F = 17A, di/dt = 100A/µs

Notes:
5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
6. Thermal resistance from junction to solder point (on the exposed drain pin).
7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.

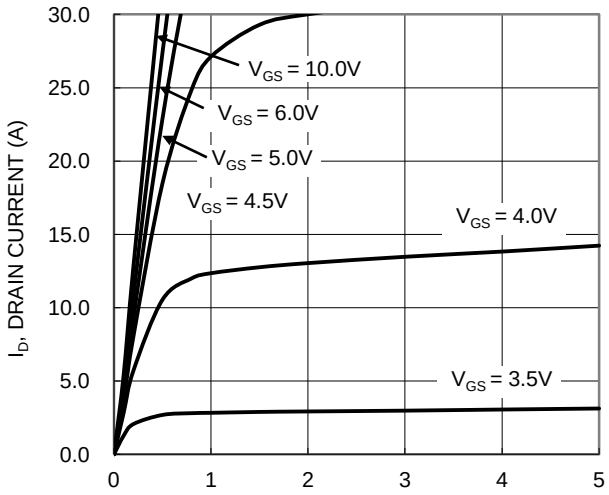


Figure 1.Typical Output Characteristic

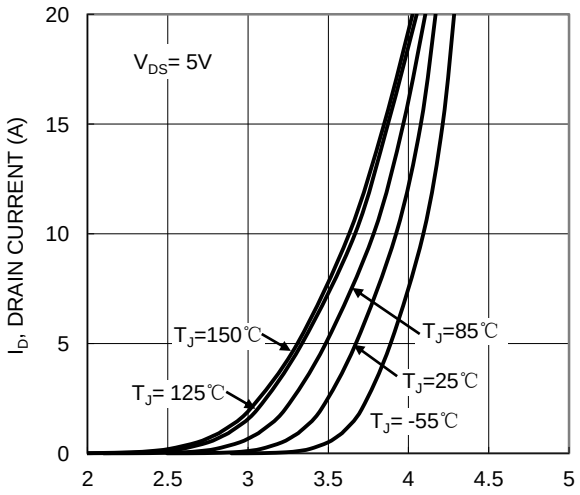


Figure 2. Typical Transfer Characteristic

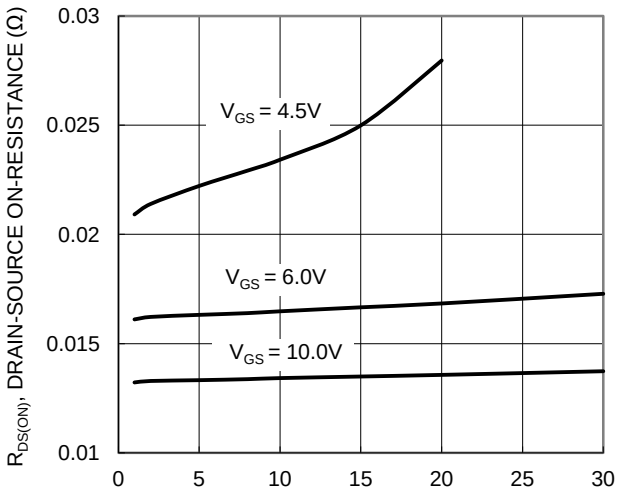


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

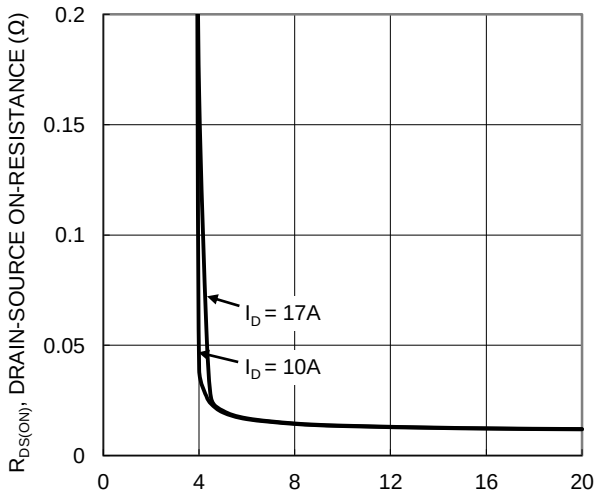


Figure 4. Typical Transfer Characteristic

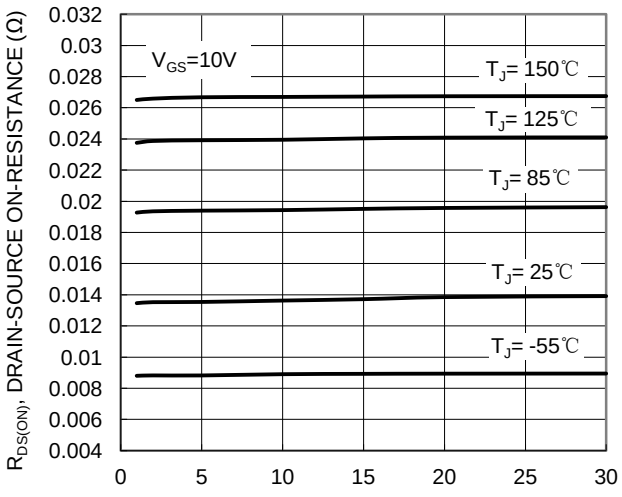


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

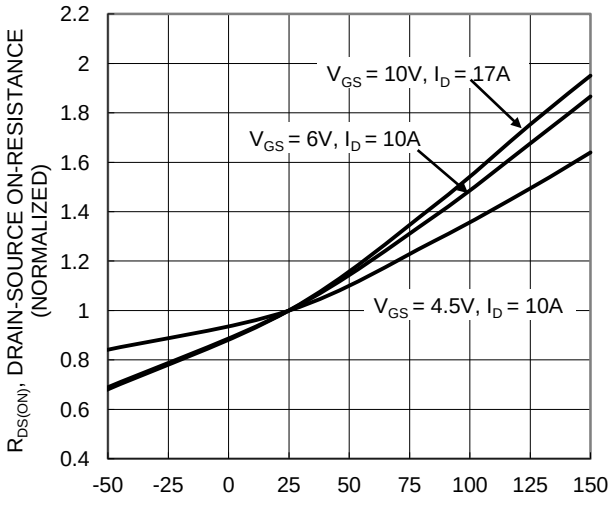


Figure 6. On-Resistance Variation with Temperature

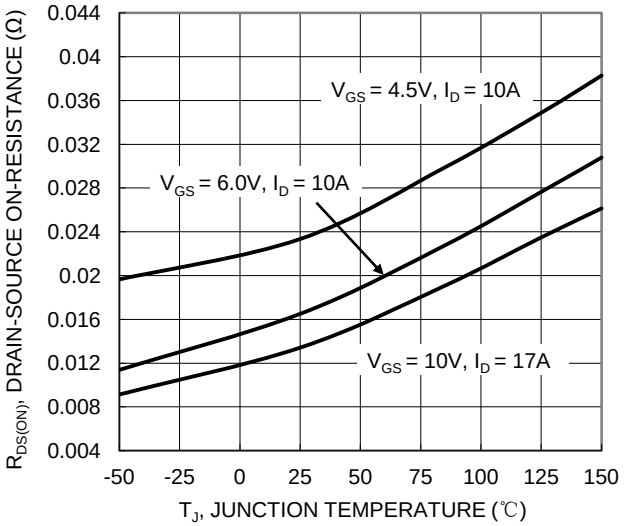


Figure 7. On-Resistance Variation with Temperature

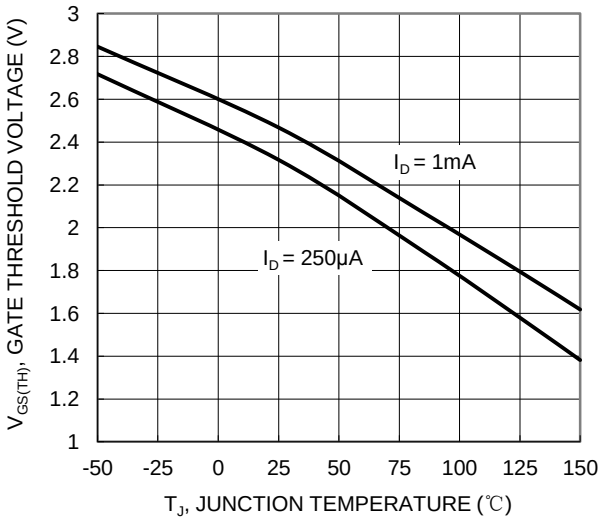


Figure 8. Gate Threshold Variation vs. JunctionTemperature

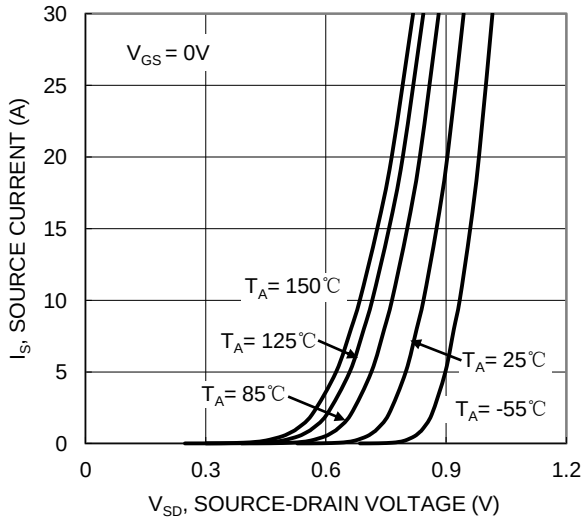


Figure 9. Diode Forward Voltage vs. Current

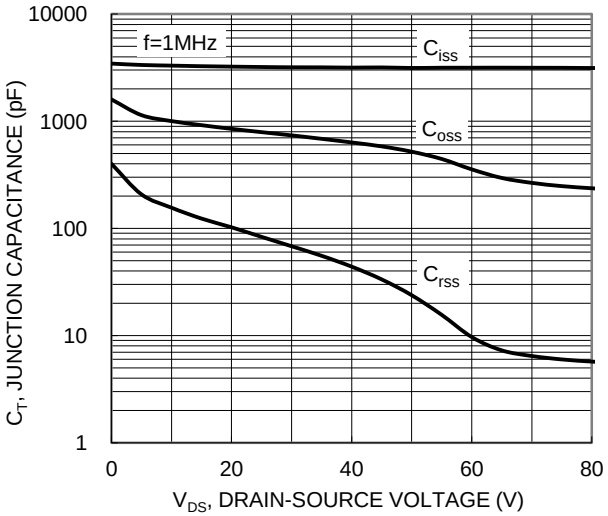


Figure 10. Typical Junction Capacitance

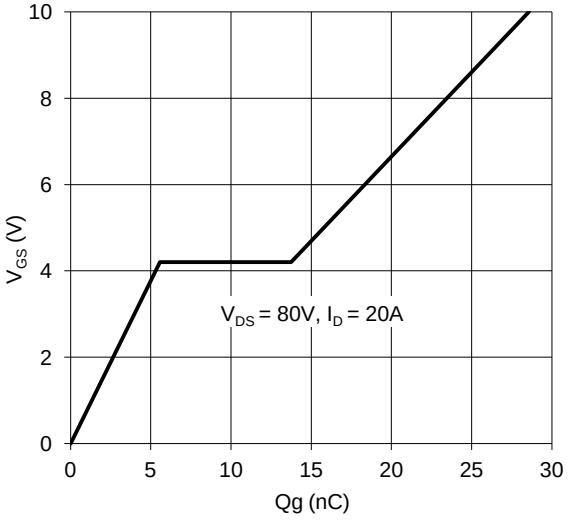


Figure 11. Gate Charge

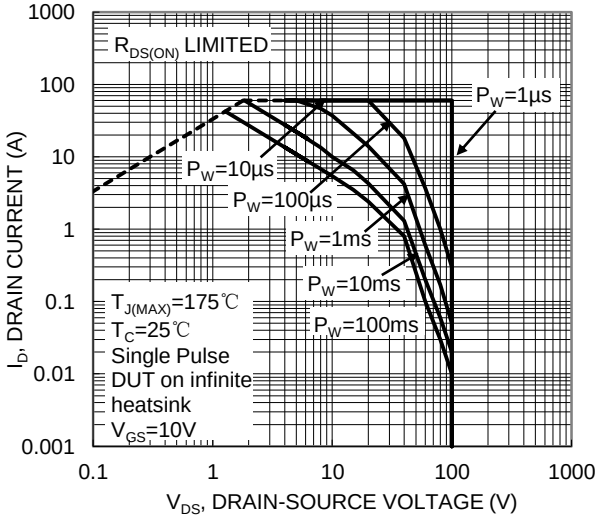


Figure 12. SOA, Safe Operation Area

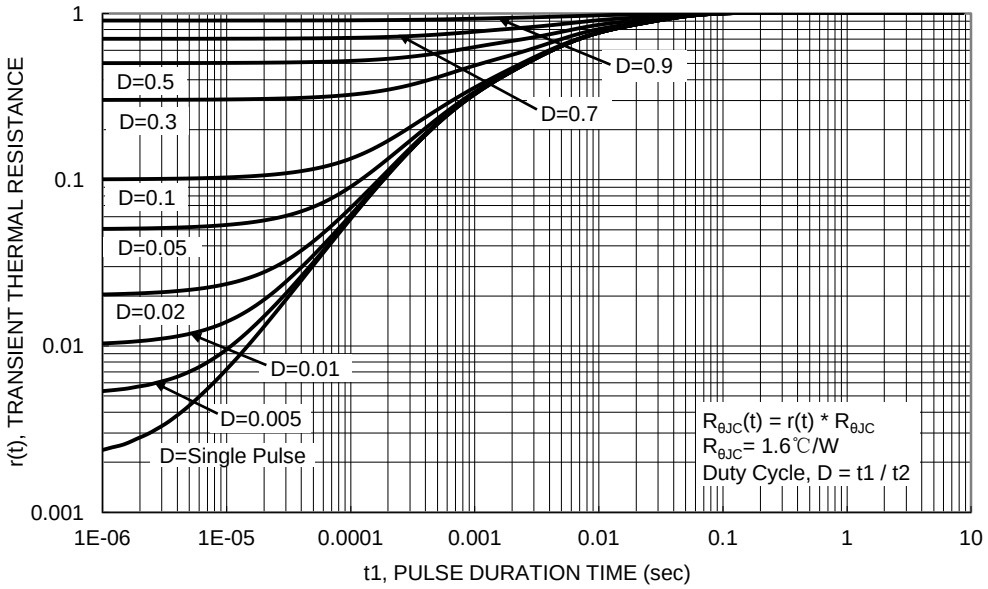
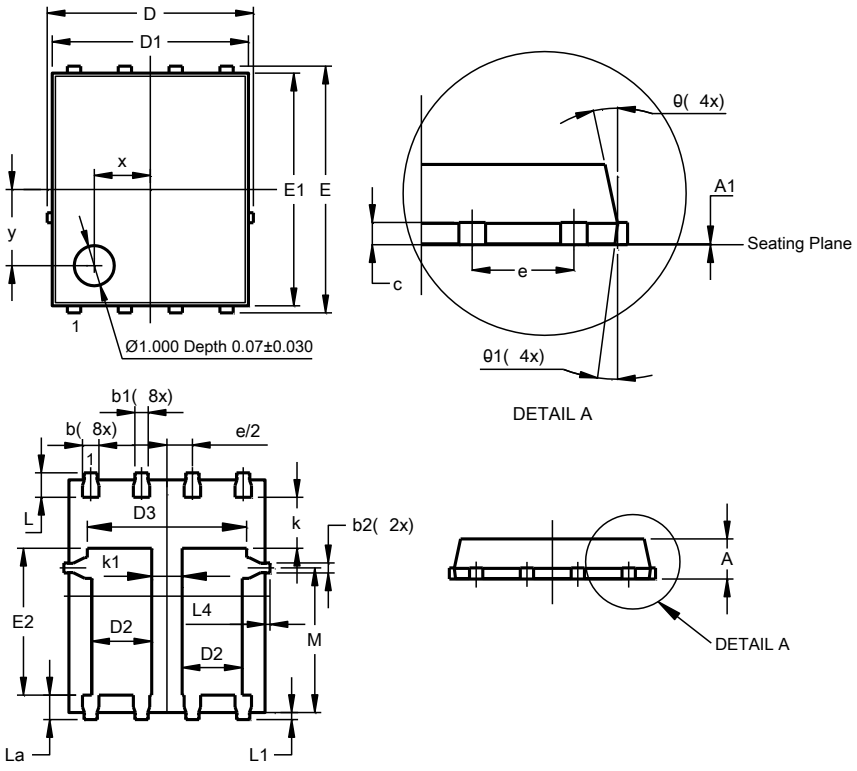


Figure 13. Transient Thermal Resistance

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type E)

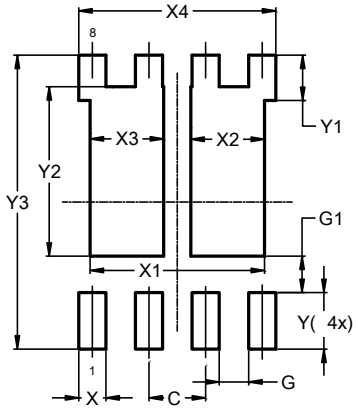


PowerDI5060-8 (Type E)			
Dim	**Min**	**Max**	**Typ**
A	0.90	1.10	1.00
A1	0	0.05	0.02
b	0.33	0.51	0.41
b1	0.300	0.366	0.333
b2	0.20	0.35	0.25
c	0.23	0.33	0.277
D	5.15 BSC		
D1	4.85	4.95	4.90
D2	1.40	1.60	1.50
D3	-	-	3.98
E	6.15 BSC		
E1	5.75	5.85	5.80
E2	3.56	3.76	3.66
e	1.27BSC		
k	-	-	1.27
k1	0.56	-	-
L	0.51	0.71	0.61
La	0.51	0.71	0.61
L1	0.05	0.20	0.175
L4	-	-	0.125
M	3.50	3.71	3.605
x	-	-	1.400
y	-	-	1.900
θ	10°	12°	11°
θ1	6°	8°	7°
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type E)



Dimensions	Value (in mm)
C	1.270
G	0.660
G1	0.820
X	0.610
X1	3.910
X2	1.650
X3	1.650
X4	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610

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